

## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

### Title of Invention

Molded Stiffener for Thin Substrates

Application Number : 10/077554  
Confirmation Number: 3265  
First Named Applicant: Chad Cobbley  
Attorney Docket Number: MTI-31591  
Art Unit: 2814  
Examiner: Hoa B Trinh  
Search string: ( 6599365 or 6584897 or 6440777 ).pn



### US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
WZ	1	6599365	2003-07-29	Jiang et al.	B1	118	504
	2	6584897	2003-07-01	Cobbley et al.	B2	101	127
	3	6440777	2002-08-27	Cobbley et al.	B2	438	118

### Signature

Examiner Name	Date
Viet Ho Trinh	6/25/06